



2007 3rd Quarter Results Investor Conference

19 November, 2007

Advanced Semiconductor Manufacturing
Corporation Limited

Agenda

❖ Welcome

❖ 2007 Q3 financial results

Ms. Cheng Jianyu
Executive Director & CFO

❖ 2007 Q4 Outlook

Mr. Hsueh Cheng Lu
Executive Director, President and CEO

❖ Q&A

2007 Q3 Overview (QoQ)

- Revenue increased 23% over 2Q07 to RMB 333.4 million in 3Q07
- Overall capacity utilization rate substantially improved to 76% in 3Q07 from 62% in 2Q 07 as a result of seasonal demand
- The 8-inch line yield stayed at record high of 98% in 3Q07, while the 6-inch fab hit record high utilization rate
- The debt level reduced significantly along with the payment of outstanding bank loan in installments
- Net profit amounted to negative RMB 22.9 million, EBITDA was positive at around RMB 78.1 million

Q3' 2007 Results Review

Amount: RMB Million	Q3'07	Q2'07	Q3'06
Sales	333.4	271.2	350.5
Net Income	(22.9)	(35.4)	9.4
Cash & Cash Equivalent	85.4	62.5	389.4
Interest-Bearing Loans	277.9	370.4	751.3
Shareholders' Equity	1718.9	1741.8	1832.3
FAB Utilization (%)	76%	62%	71%
ROE (%)	-5.3%	-8.1%	2.1%

Q3' 2007 Income Statement (QoQ)

Amount: RMB Million

	Q3'2007 Actual		Q2'2007 Actual		QoQ
	Amount	%	Amount	%	%
Net Sales	333.4	100%	271.2	100%	23%
Cost of Goods Sold (COGS)	(325.4)	-98%	(291.1)	-107%	12%
Gross Profit	8.1	2%	(19.9)	-7%	-141%
Total Operating Expenses	(29.4)	-9%	(31.4)	-12%	-6%
Operating Income/(Loss)	(21.3)	-6%	(51.2)	-19%	-
Financing Cost	(7.0)	-2%	(10.6)	-4%	-34%
Other Income/(Expenses), Net	3.1	1%	8.4	3%	-63%
Income/(Loss) Before Tax	(25.2)	-8%	(53.4)	-20%	-
Income Taxes Credit/ (expense)	2.3	1%	18.0	7%	-
Net Income/(Loss)	(22.9)	-7%	(35.4)	-13%	-

Q3' 2007 Income Statement (YoY)

Amount: RMB Million

	Q3'2007 Actual		Q3'2006 Actual		YoY
	Amount	%	Amount	%	%
Net Sales	333.4	100%	350.5	100%	-5%
Cost of Goods Sold (COGS)	(325.4)	-98%	(310.9)	-89%	5%
Gross Profit	8.1	2%	39.6	11%	-80%
Total Operating Expenses	(29.4)	-9%	(23.5)	-7%	25%
Operating Income/(Loss)	(21.3)	-6%	16.0	5%	-
Financing Cost	(7.0)	-2%	(12.3)	-3%	-43%
Other Income/(Expenses), Net	3.1	1%	6.4	2%	-52%
Income/(Loss) Before Tax	(25.2)	-8%	10.2	3%	-
Income Taxes Credit /(Expense)	2.3	1%	(0.8)	0%	-
Net Income/(Loss)	(22.9)	-7%	9.4	3%	-

Q3' 2007 Balance Sheet

Amount: RMB Million	Q3 07		Q207		Q3 06	
Selected Items from Balance Sheet	Amount	%	Amount	%	Amount	%
Total Assets	2240.8	100%	2316.4	100%	2956.6	100%
Cash & Cash Equivalent	85.4	4%	62.5	3%	389.4	13%
Accounts Receivables & Other	182.5	8%	188.8	8%	213.4	7%
Inventory	218.9	10%	235.7	10%	263.2	9%
Total Current Assets	486.9	22%	487.0	21%	866.1	29%
Accounts Payable	152.7	7%	124.6	5%	212.3	7%
Current Portion of Loans	277.9	12%	281.3	12%	283.1	10%
Accrued Liabilities & Others	91.2	4%	79.7	3%	150.7	5%
Total Current Liabilities	521.9	23%	485.5	21%	646.1	22%
Long Term Debt	0.0	0%	89.1	4%	468.2	16%
Total Equity	1718.9	77%	1741.8	75%	1842.3	62%
Accounts Receivable Turnover (days)	41		54		45	
Inventory Turnover (days)	63		73		71	
Current Ratio	0.93		1.00		1.34	
Net Working Capital	(35.0)		1.5		220.0	

Q3' 2007 Cash Flow

Amount: RMB Million

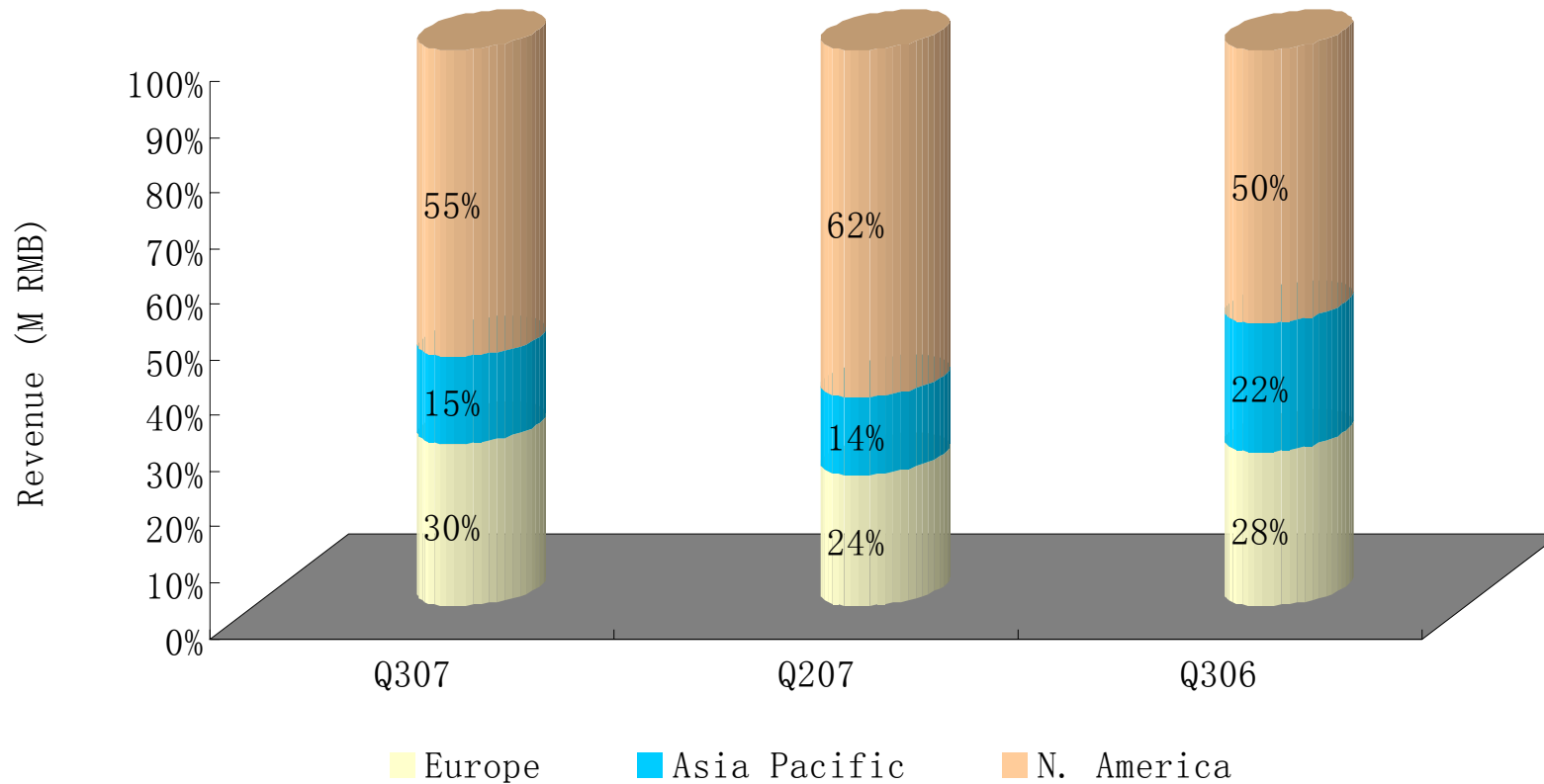
	Q3'07	Q3'06
	Amount	Amount
From Operation	134.4	23.5
Profit Before Tax	(25.2)	10.2
Depreciation & Amortization	96.4	99.9
Change in Working Capital	59.2	(86.9)
Other Operating activities	4.0	0.3
From Investment	(20.4)	(8.0)
Capital Expenditures (Net)	(20.4)	(8.0)
Other Investment Sources/(Uses)		
From Financing	(92.5)	(26.8)
Repayment of -L	(92.5)	(26.8)

Q3' 2007 Capital Expenditures

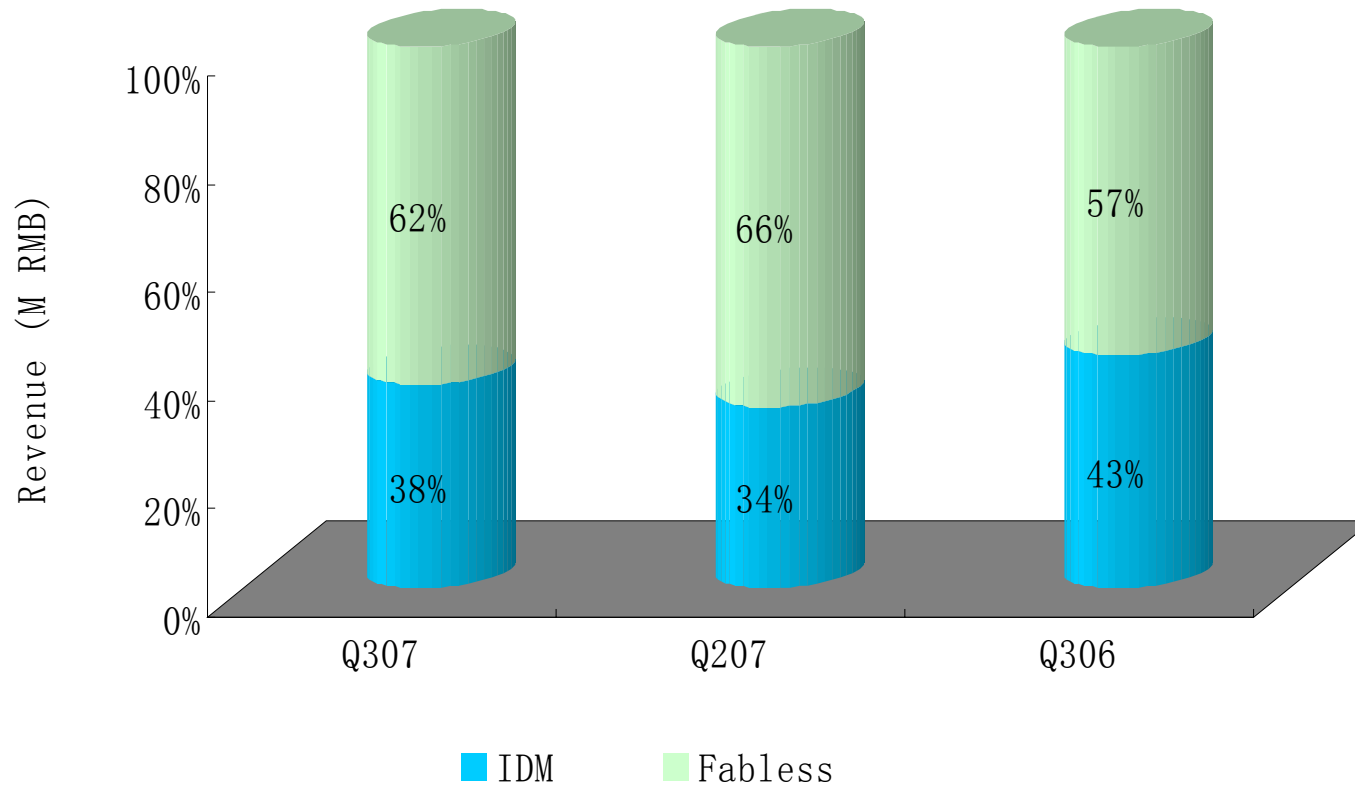
Amount: RMB Million

	Q3'07	Q2'07	Q3'06
CAPEX	Amount	Amount	Amount
	20.4	1.4	8.0

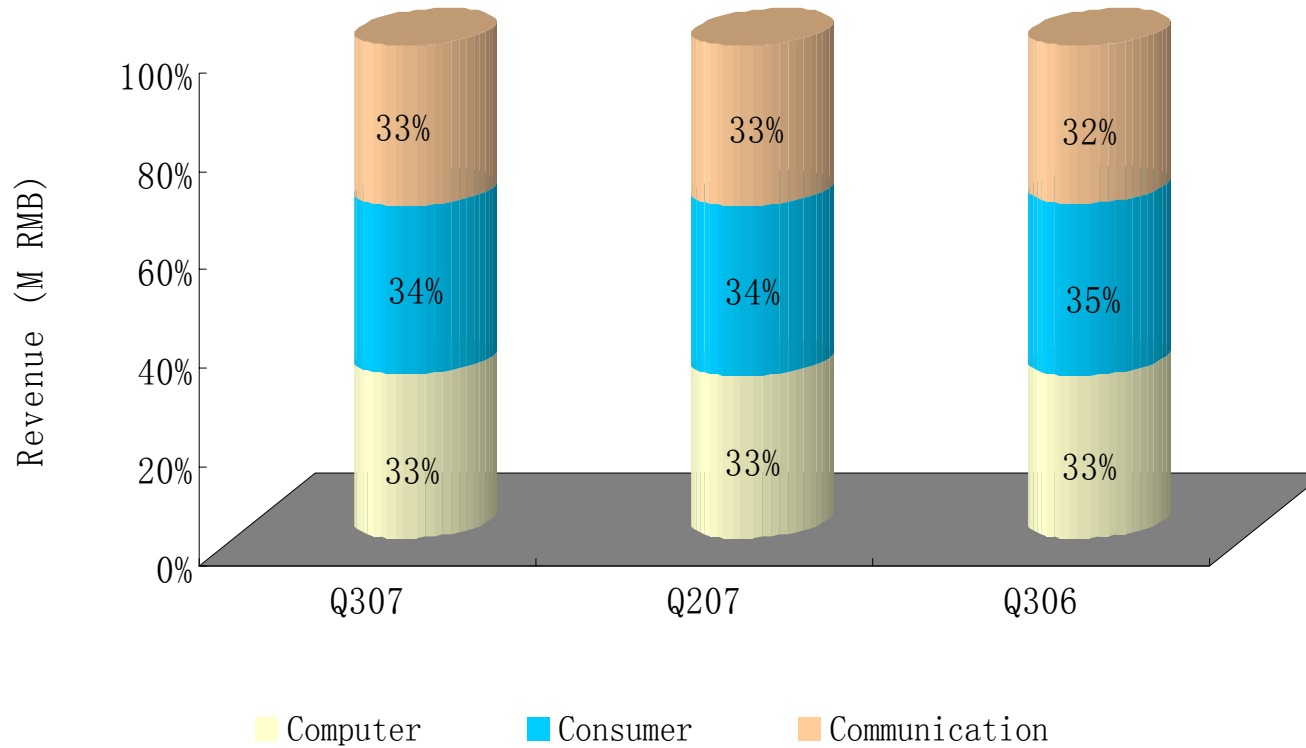
Sales Breakdown by Geography



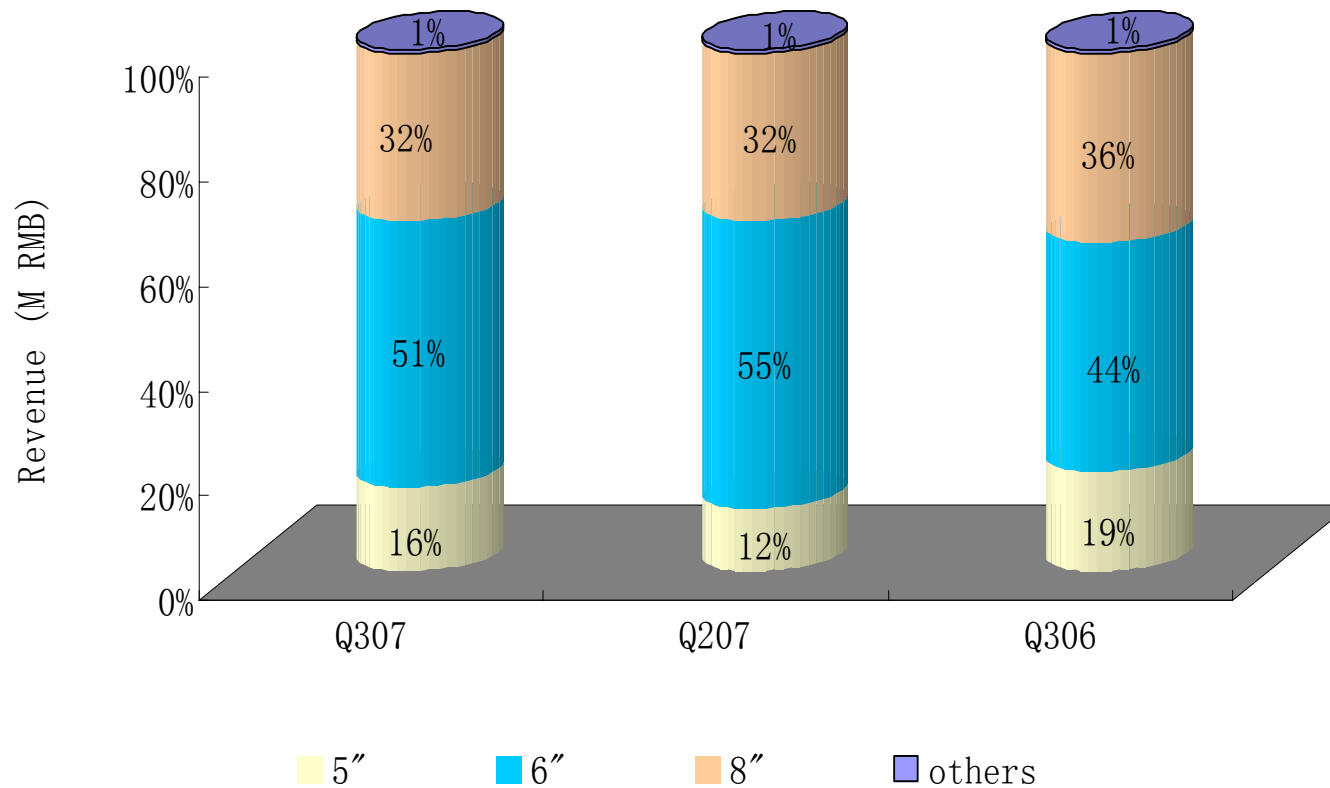
Sales Breakdown by Customer



Sales Breakdown by Application



Sales Breakdown by 5", 6" and 8"



FAB Installed Capacity (8" Equivalent)

FAB / (Wafers in thousand)	Q3 07	Q2 07	Q3 06
Fab 1/2			
5-inch wafers	33	33	33
6-inch wafers	85	85	85
Fab 3			
8-inch wafers	36	36	36
Total 8" Equivalent	154	154	154

Note: The Company estimated the capacity of its 5-inch, 6-inch and 8-inch on the basis of 9,10 and 22 mask steps per wafer respectively and 5-inch, 6-inch wafers were converted to 8-inch equivalent wafers by dividing their wafer number using 2.56 and 1.78 respectively.

Capacity Utilization Rate by Fab

FAB	Q3 07	Q2 07	Q3 06
Fab 1/2			
5-inch wafers	72%	43%	81%
6-inch wafers	87%	74%	71%
Fab 3			
8-inch wafers	65%	55%	68%
Overall Capacity Utilization Rate	76%	62%	71%

Note: The capacity utilization rate represents the percentage of the actual number of processing steps (measured by the number of masks used) for the number of semiconductor wafers shipped in the reporting period divided by the total number of processing steps a fab is capable to produce during the corresponding period.

Outlook for the fourth quarter of 2007

- Semi-industry is expected to show normal seasonal decline due to typical year-end holiday
- Recent longer power outage incident, has resulted in serious damage to processed wafer as well as interruption of overall production.
- The great efforts being made to resume production. Up till now, both 5-inch, 8-inch has basically resumed production while the recovery of 6-inch is well under way and expected to be completed early in 2008
- The Company's sales in 4Q07 expected to reduce by approximately RMB 100 million

For further information

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